

RF Applications

CERN Accelerator School Mechanical & Materials Engineering for Particle Accelerators and Detectors

Dr. Thomas Geoffrey Lucas Tenure-Track Scientist Sint-Michielsgestel, 13 June 2024



Overview



- Foreword
- Introduction to RF
- General Applications
- RF Cavities
- RF Transmission
- Thermal Analysis
- Ultrahigh Precision Machining
- Closing Remarks



Foreword



We will concentrate on classical normal conducting RF systems. We will not cover the particular engineering aspects of Superconducting RF systems.

We will illustrate via few examples, *most related to applications and developments at PSI*, the mechanical engineering aspects relevant for the desing and production of RF accelerating structures and RF components.

Beside some key formula, basic concepts and key parameters we will try to minimize the mathematics and concentrate on the interface between RF requirements and mechanical engineering/production.

I would like to begin with an acknowledgement of Dr. Marco Pedrozzi who wrote the original slides that this talk was based on.

Constraints of RF Systems



RF systems are always (very) expensive

 \Rightarrow It is not uncommon if representing a large fraction of the total accelerator/project budget.

RF handles high power & voltages

- \Rightarrow Complex system with high potential of failures (can strongly influence the accelerator reliability).
- \Rightarrow Requires careful design and engineering .
- \Rightarrow Engineers must always consider maintainability during the design phase.

Some other constraints

- ⇒ Choice of the RF frequency is often restricted to already existing (commercial) RF sources & components. Developments may be unavoidable but deviations from standards imply substantial additional costs and time.
- \Rightarrow Space in the existing or planned (costs) facilities.
- \Rightarrow Significant development and procurement time.

Paul Scherrer Institut







Introduction to RF and some common nomenclature

Definition of Radio-Frequency (in accelerators)





Nomenclature Frequency bands



	Frequency Band	Frequency Range	Wavelength	
	HF	3 MHz to 30 MHz	10 meter to 1 meter	
	VHF	30 MHz - 300 MHz	1,000cm to 100cm	
Turinel for Electron	UHF	300 MHz - 1 GHz	100cm to 30 cm	lon accelerators
	L band	1 GHz to 2 GHz	30cm to 15cm	
accelerators	S band	2 GHz - 4 GHz	15cm to 7.5cm	
	C band	4 GHz - 8 GHz	7.5cm to 3.8cm	
	X band	8 GHz - 12 GHz	3.8cm to 2.5cm	
	K _u band	12 GHz - 18 GHz	2.5 to 1.7 cm	
	K band	18 GHz - 27 GHz	1.7 to 1.1 cm	
	K _a band	27 GHz - 40 GHz	1.1 to 0.75 cm	
	V band	40 GHz - 75 GHz	0.75 to 0.40 cm	
	W band	75 GHz - 100 GHz	0.40 to 0.27 cm	
	mm	110 to 300 GHz	0.27 to 0.10 cm	

Example S-Band in Linacs: US frequency **2.856 GHz** - European frequency **2.998 GHz** (different standards)

Small Parenthesis: Definition of eV



A practical unit for particle energy is the electron-Volt 1 eV = 1.602×10^{-19} J

This is the amount of energy that one electron gains in one volt of potential.





RF vs DC acceleration



~0.2m



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1 MV Cockcroft-Walton: the first stage in the High Intensity Proton Accelerator (HIPA) facility

HV Housing of the ~1 **MeV Proton source**



7.1 MeV SwissFEL **RF-Gun Peak** gradient 100 MV/m

SwissFEL C-Band RF-

Module Gradient ~30

(the cavities would

allow >56 MV/m if

enough RF power)

pulse

MV/m







RF in Particle Accelerators

Typical Accelerator Topology





RF Systems in Accelerators





Applications of RF (1/3)



Particle Acceleration (mentioned in previous slides)

The most direct and obvious use of RF in a particle accelerator is the acceleration of particles. The RF system is what generates the high energies.



Particle Deflection for diagnostics

One can also accelerate the beam sideways. Depending on where you are on the RF you can kick the beam transversely or rotate the beam such that the head and tail are distributed transversely.



Applications of RF (2/3)



Particle Deflection for collision

Rotating the beam can also be used for colliders where the deflections allows better overlap between the two colliding bunches.



Particle Gymnastics

Manipulating the bunch shape (compression, expansion, linearisation, etc.) is possible through the use of RF. Some beam gymnastics requires a different frequency from the used for acceleration.



Applications of RF (3/3)



Particle Acceleration after Generation

RF can be used to accelerate the bunch after its generation. If you apply enough electric field you can even generate particles from a surface using the RF!



RF compression

RF components known as a pulse compressor can be used to exchange pulse length for pulse high.







RF Cavities

Let's look more closely at the first application: Acceleration!

Electromagnetic Modes



- Electromagnetic modes can exist in a cavity analogous to harmonics on a guitar string.
- Boundary conditions determine the frequency that can resonate.
- Transverse Magnetic (TM) and Transverse Electric (TE) modes can exist in cylindrical cavities.





Image from: https://www.fuelrocks.com/how-to-make-your-guitar-string-vibrate-at-its-fundamental-frequency-mode/

Basic RF Accelerating Structures: The Pill Box Cavity

- In a cylindrical WG TE and TM modes can be sustained.
- Fundamental mode for accelerating structures is the TM₀₁₀.
- This mode is wonderful for acceleration (see right). This mode's frequency is given as:

2.40483 c









The higher the frequency, the tighter are the mechanical tolerances

13.06.2024

More Realistic Types of Accelerating Structures







Constraints: The longitudinal size of the cells and spacing musts be adjusted to the transit time of the particle bunches to keep the synchronism with the RF

Typical Power Related Parameters of RF cavities



The magnetic field H tangential to the surfaces induce a current $\vec{J}_A = \vec{n} \times \vec{H}$ in the skin depth δ



Reprint: Meinke, H. and Gundlach, F. W., Taschenbuch der Hochfrequenztechnik, Dritte Auflage, Springer-Verlag, Berlin (1968)

Some basic parameters you may face discussing with the RF designer



 P_{ext} $\beta = \frac{P_{ext}}{P_{loss}}$ Coupling factor from an external power source β =1 matched to the wall losses (no Beam) \Rightarrow ext. source just compensating the losses $Q_{ext} = \frac{\omega_0 W}{P_{oxt}} = \frac{Q_0}{\beta}$ (P_{ext} can be alternatively interpreted as the losses from the coupler when the RF source is turned off) With external source the total quality factor becomes $Q_L = \frac{Q_0}{1+R}$ Shunt impedance: $R = \frac{|V_{acc}|^2}{2P_{loss}}$ \longrightarrow Optimized by the RF designer to minimize the power requirements Two ports measurement S21 1.00 R «upon» Q: $\frac{R}{Q} = \frac{|V_{acc}|^2}{2\omega W_0}$ 0.75 Figure of merit of the cavity shape (material independent) as high as possible *S*₂₁ 0.50 Cavity Bandwidth: $\Delta \omega = \frac{\omega_0}{2Q_L}$ $\sim 2\Delta\omega$ 0.25 Cavity filling time: $\tau_L = \frac{1}{\Lambda_{CD}}$ 0.00 -2 -1 0 1 2 $(\omega - \omega_0)/\Delta \omega$

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 \vec{E}

How to adjust the Resonant frequency



Permanent adjustment

- Inelastic deformation of the cavity wall after manufacture
- Or, very precise manufacturing

Dynamic adjustment:

- deformation of the cavity wall in elastic regime (fast)
- Motorized plunger (fast)
- Temperature variation (slow)

Radius	Res. Freq.	Δf with + 1°C
0.0382	3000	-51
0.23	500	-8.52
2.2	52.2	-0.89

Example Pillbox resonant frequency variation for + 1 °C





Tendencies for frequency tune methods					
	High Freq. :	fix tune & temperature			
	Low freg. :	elastic deformation & plunge			

Oxygen Free High Conductivity (OFHC) Copper material of choice for RF structures



PSI Specifications for SwissFEL:

The impurities shall be in accordance with ISO 431 except:

Reasons

- · Relatively easy to machine & with roughness at nm level
- Low Secondary Emission coefficient to reduce multipacting & breakdown risks
- Excellent electrical (and thermal) conductivity ⇒ minimize power dissipation
- Easy to braze/weld
- · Good availability and reasonable cost

Copper must be 3D forged

- To increase mechanical uniformity, hardness and strength of the material
- Minimize number and size of defects, cracks and empty inclusions that could lead to craters or virtual leaks in vacuum after machining.

Suitable for high RF accelerating gradients

Liement	
Copper	99.99
Cadmium max.	0.0001
Phosphorus max.	0.0003
Sulphur max.	0.0018
Zinc max.	0.0001
Mercury max.	0.0001
Lead max.	0.001
Selenium max.	0.001
Tellurium max.	0.001
Bismuth max.	0.001
Arsenic	
Antimony	Total of these
Bismuth	seven elements
Selenium	not to exceed 40
Tellurium	ppm
Tin	
Manganese	

Elamant

The Spectrum of RF (Cavities)





50 MHz Ring Cyclotron





50 MHz Inj. II



150 MHz buncher

6 GHz TW-SwissFEL After brazing at PSI



12 GHz

500 MHz Super-buncher



3 GHz RF-Gun SwissFEL



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12 GHz Disc



PSI Center for Accelerator Science and Engineering

Resonant cavities: few important information to be kept



- The resonant frequency depends on the dimensions of the cavity. Active deformations are used to tune the frequency but unwanted mechanical deformations (effect of vacuum, thermal excursions, stress) have the same effect
- The highest the frequency the most sensitive is the RF structure to manufacturing tolerances or deformations ⇒ to match the design resonant frequency within the allowed tuning range
- The power losses can be minimized with a "smart" RF design. Materials are of course important (OFHC copper). Thermal analysis starting from the simulated RF losses helps optimizing the design
- The highest the unloaded quality factors Q₀ the lower are the wall losses, and narrow the bandwidths
 of the structure. The final quality factor Q₁ depends on the coupling factor to the source.
- The near collaboration between RF and mechanical engineer in an iterative process is essential to rapidly converge to a feasible and (reasonably) optimized design. Compromises between RF performances and mechanical feasibility can't be avoided.



RF Transmission and (a couple of words on coupling).

Transmission line: Coaxial



Very common transmission line for low power sig

$$Z \approx \frac{60}{\sqrt{\varepsilon_r}} \ln\left(\frac{D}{d}\right) \quad [\Omega]$$

Impedance of the line

 $Z = 50 \Omega \iff D/d = 2.302$

 $Z = 75 \Omega \iff D/d = 3.493$

 \vec{E} D d TEM



See for example: https://www.zseries.in/electronics%20lab/cab les/coaxial/#.YGrbtu2xViE

No cutoff frequency for TEM mode, but for high frequencies and large dimensions other modes (with cut off are present) => limitation for high power @ Commercial rigid coax. from high frequency Spinner

For high power **rigid** coaxial lines \Rightarrow difficulty: cooling of central conductor



Some Rigid coaxial standards (50 Ω)

Standard designation		
Size in inch	D (mm)	d (mm)
1-5/8"	38.79	16.87
3-1/8"	76.89	33.40
4-1/16"	99.95	43.46
6-1/8"	151.92	66.04
9-3/16"	228.60	99.31

More on coax. See for example: https://cds.cern.ch/record/865921/files/p210.pdf

Transmission line: Waveguides Rectangular WG basics



13.06.2024

For High Power, high frequency and narrow-band applications rectangular Waveguide are commonly used to transport the RF power from the source to the RF structure.

- A WG allow the propagation of different modes with different cutoff frequencies (f_c) . ٠
- The size is selected depending on the chosen RF frequency to keep one single mode propagating •



	Cutoff Next mode (GHZ)	Cutoff TE10 (GHz)	B (mm)	A (mm)	Standard Freq Range (GHz)	WR Designation
	3.47	1.74	43.180	86.360	2.20 - 3.30	WR340
S-Band	4.16	2.08	34.036	72.136	2.60 - 3.95	WR284
J-Danu	5.15	2.58	29.210	58.166	3.30 - 4.90	WR229
C-Band	6.30	3.15	22.149	47.549	3.95 - 5.85	WR187
e bana	7.42	3.71	20.193	40.386	4.90 - 7.05	WR159
	8.60	4.30	15.799	34.849	5.85 - 8.20	WR137
	10.52	5.26	12.624	28.499	7.05 - 10.00	WR112
X-Band	13.11	6.56	10.160	22.860	8.2 - 12.4	WR90
	15.74	7.87	9.525	19.050	10.0 - 15.0	WR75
	18.98	9.49	7.899	15.799	12.4 - 18.0	WR62

Inside dimension

Standard WG (Industrial references are easily available on the Internet)

(TE₀₁)

Transmission line: Waveguides







European IEC Standard Flanges



Reprint standard flanges from: <u>https://www.microwave-link.com/microwave/microwave-waveguide-flange/</u>

ATM '-8'

North American EIA Standard Flanges

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Transmission line: Waveguides and Coaxial Lines Important Takeaways

- Waveguides and Coaxials are the main ways to transport RF between Systems.
- Coaxial is used generally at low power and nearly always for low frequency as waveguides become too large.
- Waveguides are used for mid to high power, high frequency applications.
- Rigid coax lines are necessary to handle high power. For RF frequencies higher than ~500 MHz rigid coax are not suited for high power (>100 kW)
- Waveguide are standardized industrial products, the operating frequency determines the WG dimensions
- The RF and mechanical design of the interface with the RF structure must be matched to the required WG standard
- Waveguide can be operated in Vacuum, on air or with insulating gases as Sulfur hexafluoride (SF6) => Flange quality is essential
- No Cutoff frequency for the TEM Mode (Coaxial). Signals can propagate from DC to high frequencies. Waveguide have a finite bandwidth.
- High power operation in vacuum requires very clean surfaces. An advantage if compatible with 120-150 °C bake-out
- The best waveguide flanges were designed by acc. Institutes and commercialized => good electrical contact and vacuum compatibility





SwissFEL RF-Gun



Couplers and Windows: Examples





500 MHz Coaxial coupler SLS



A metallic thin coating on the vacuum side of the ceramic is commonly used to suppress multipactor and avoid accumulation of charges \Rightarrow prevents discharges

* Reprint window from: Julien Hillairet, et al.. Design and Tests of 500kW RF Windows for the ITER LHCD System. Fusion Engineering and Design, Elsevier, 2015



Thermal Analysis

Thermal analysis & RF design

For high power applications (large wall losses) a detailed thermal analysis is required to refine both RF and mechanical design in order to:

- avoid hot spots & deformations, detuning of the structures) and damages ٠
- optimize cooling channels •

Multi-physics simulations are therefore required (for example using ANSYS*)



*https://www.ansys.com/

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mechanical engineer

** For more details on the RF-Gun design: J.-Y. Raguin et al, Proceedings of LINAC2012, Tel-Aviv, Israel

37 313

36.331

35 349

32,402 33,384 34,366

329.149





.382E+08

Stress analysis SwissFEL C-Band module



FEA boundary conditions for stress estimation due to thermal eleongations

- All cavity supports translational+rotational fixed in XYZ direction (3 point bearing)
- Each cavity is supported by 1 fixation in XYZ + 2 fixations in XY (with "Coupled DOF")
- All structures have temperatures of T_{initial} = 25°C and T_{thermal load} = 50°C (operation 30 °C)



Stress analysis SwissFEL C-Band module







Ultrahigh Precision Machining

'Typical' Ultrahigh Precision: SwissFEL Injector S-band structu

PSI RF design

- Constant gradient + constant losses
- Dual feed racetrack couplers

Classical technology with cell to cell dimple tuning after brazing

Manufacturing incl. machining, brazing & tuning by Research Instruments (2008-09)

Parameter	Value
Operating frequency	2998.8 MHz
Phase advance per cell	$2\pi/3$
Total number of cells	122
Accelerating gradient	20 MV/m
Maximum pulse repetition frequency	100 Hz
Operating temperature	30°C

		v_g/c (%)	r/Q (k Ω /m)	Q
Firs	t cell	2.91	3.85	11688
Mic	idle cell	1.87	4.23	11640
Las	t cell	0.79	4.81	11589



Geometry of 3 regular cells (120 regular cells + 2 coupling cells)



Coupler cell with waveguide





New frontiers with Ultra High Precision machining



This make sense for structures at high frequencies operating at fixe tune

The idea is to manufacture on tune => i.e. the exact dimensions of the structures as simulated by the RF engineers

Prerequisite

- Very high level of confidence in the RF design simulation tools (HFSS*, CST**, ...).
- Relay on UHP machining with tolerances in the μm range (qualify commercial partner for large series)
- In house expertise for the mechanical design and production process (need time to be established)
- In house expertise (and possibly the oven) for the brazing process

Advantages

- Structure ready for use direct after brazing.
- Avoid «long» tuning process with possible contamination of the structure surfaces
- Very low roughness of the surfaces typically Ra <15 nm

Good for high gradient applications

UHP Machining and Temperatures



Manufacturing temperature \neq operating temperature of the structure.

The dimensions on the manufacturing drawings must be adapted taking into account:

- The temperature of the UHP workshop environment (temperature stabilized)
- The final operating temperature of the cavity

Seems trivial but remember we want to achieve precisions in few µm range

UHP example: C-band linac modules





Some production infrastructure







UP-Machine HEMBRUG Slantbed-MIKROTURN-100-CNC. Was used to establish the manufacture procedure at PSI. Later delivered to the industrial partner for mass production



7 sequential cleaning baths with automatized cup handling



Automatized stacking with robot



Metrology: Leitz Infinity: accuracy 0.3 mm. PSI Center for Accelerator Science and Engineering



Handling tools



Brazing furnace @ PSI 13.06.2024

C-band structures: Assembly Procedure





C-band structures: typical straightness







End Result! SwissFEL







Closing Remarks



Close collaboration between RF and mechanical engineers is key to efficient work and it is important to work iteratively.

Important to discuss the constraints with the RF engineer to ensure the design remains feasible to build.

It is important to have a mechanical engineer within the RF design group to build the necessary knowledge in the field of RF and ensure efficient communication with the workshop and external suppliers.

The progress with the RF simulation tools and UHP machining allows extreme precise design and fabrication on tune. Prototyping phase to validate the design may be avoided or strongly reduced.

Acknowledgements



I would like to thank those that contributed to these slides

- Dr. Marco Pedrozzi and Dr. Paolo Craievich for their support in developing the slides.
- The RF Section at PSI who design these RF systems that I've shown you today.
- The CAS team for the invitation.

And thanks to you for your attention.



Any Questions?

